



P14 Rapid-2

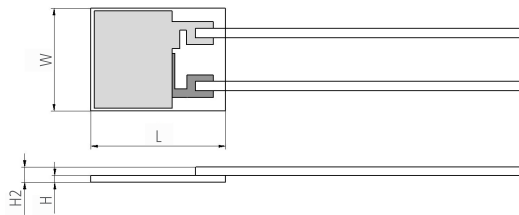
Capacitive Humidity Sensor

New version with outstanding response time
– Optimal for weather balloons and radiosondes

Benefits & Characteristics

- Extraordinary fast response time: more than 3 times faster than P14 Rapid
- Temperature shock resistant
- Fast recovery time after condensation
- Robust against icing
- Wide temperature range
- High humidity stability

Illustration¹⁾



1) For actual size, see dimensions

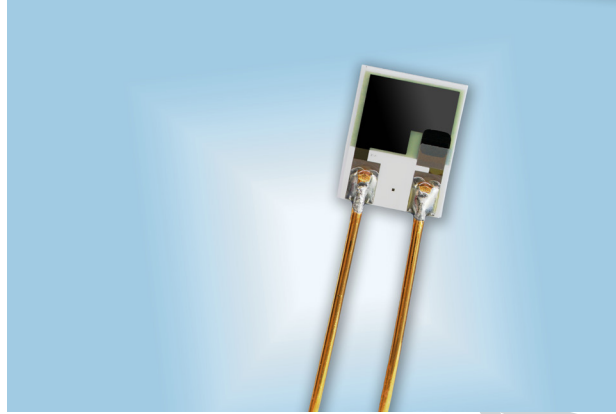
Technical Data - Preliminary

Dimensions (L x W x H / H2 in mm):	5.0 x 3.81 x 0.4 / 0.8
Capacitance at 30 % RH and +23 °C (C_{30}):	650 pF $\pm$ 150 pF
Sensitivity (C_{30} = 650 pF, 15 % RH to 90 % RH):	1.1 pF/% RH
Operating humidity range:	0 % RH to 100 % RH (maximal dew point: +85 °C)
Operating temperature range:	-80 °C to +150 °C
Loss factor:	< 0.01 (at 23 °C, at 10 kHz, at 90 % RH)
Linearity error:	< 1.5 % RH (15 % RH to 90 % RH at +23 °C after one-point calibration)
Hysteresis:	< 1.5 % RH
Response time t_{63} : ²⁾	< 0.3 s (50 % RH to 0 % RH at +23 °C)
2) The response time is often measured for increasing humidity steps, whereas physics predicts that decreasing humidity leads to generally far longer response times for capacitive humidity sensors. IST thus measures response times always for decreasing humidity values, since this is the worst case.	
Measurement frequency:	1 kHz to 100 kHz (recommended 10 kHz)
Maximal supply voltage:	< 12 V _{pp} AC
Signal form:	alternating signal without DC bias
Connection:	Au/Cu-wire, Ø 0.4 mm

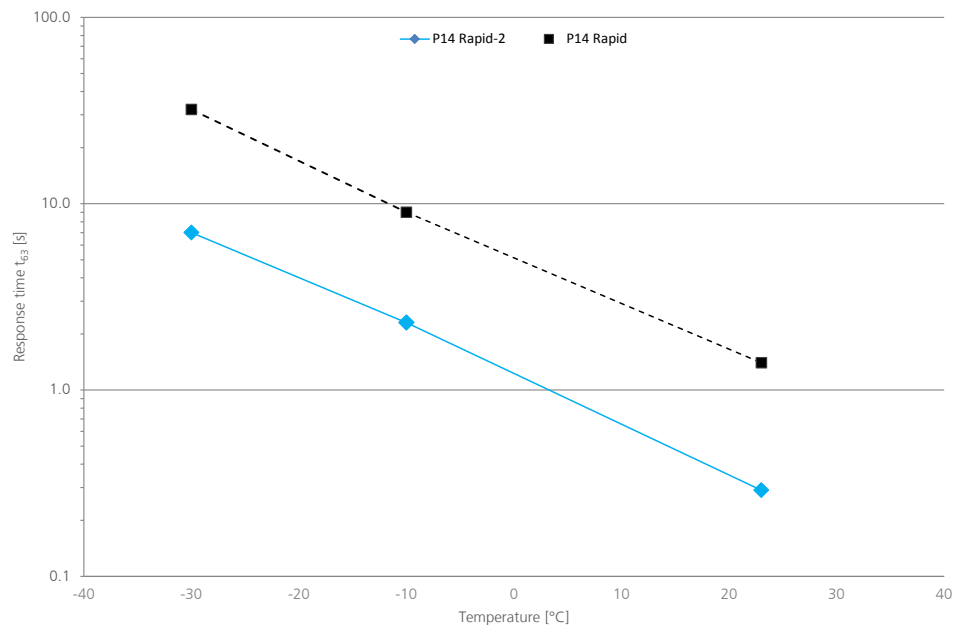
The calibration of the sensor must be done 5 days after soldering at the earliest.



Product Photo

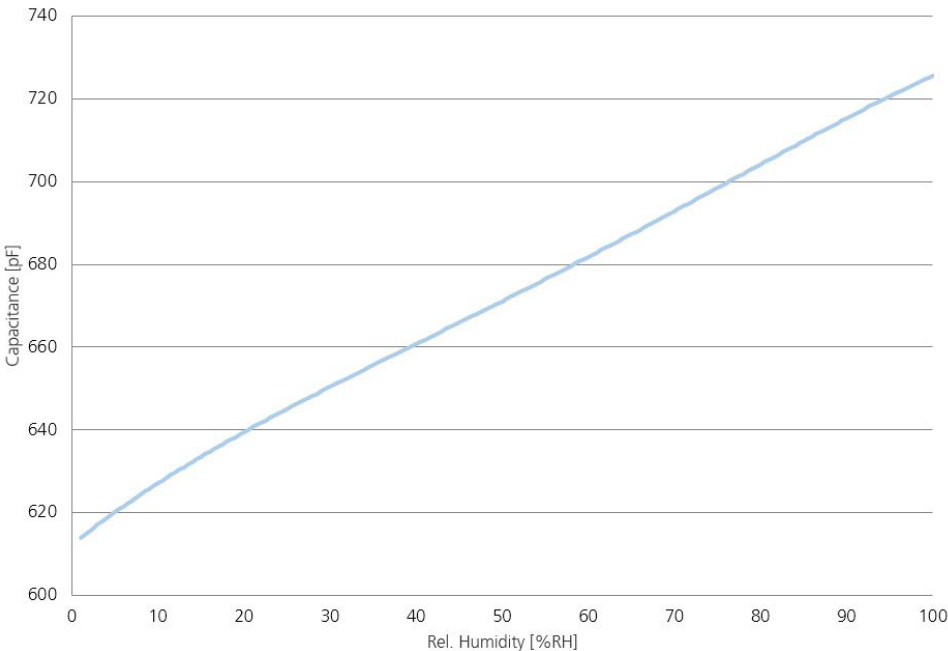


Response Time (typical)





Characteristic Curve (typical)



Order Information

Description:	Item number:	Former main reference:
P14 Rapid-2 (650±150 pF)	104932	340.00073

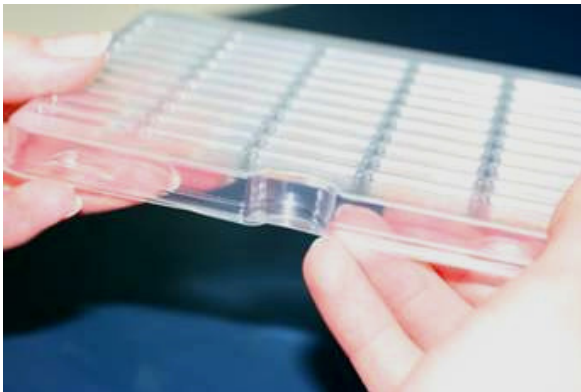


Handling

Packaging

The wired humidity sensors are packaged in blisters. Please be careful when opening the blisters to avoid any damages to the sensors.

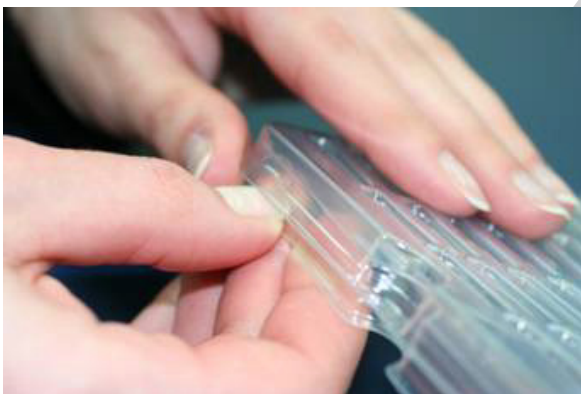
To avoid damages handle as follows:



1. Side with curve has to face you.



2. Push your thumb beneath cover and press carefully lock system until cover removes smoothly.



3. Press lock system on second side on the same way.



4. Remove cover slowly.

Storage

Sensors have to be stored only in the original blisters.

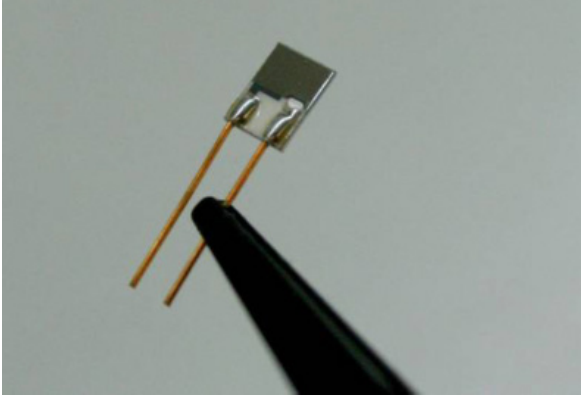
Storage environment :

-20°C...+50°C /-4...122°F (temperature range of blister)

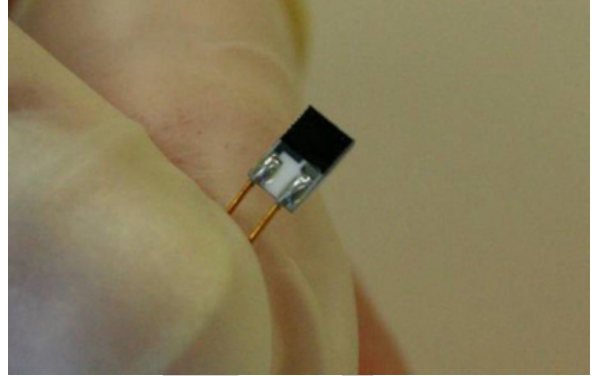


Sensor handling

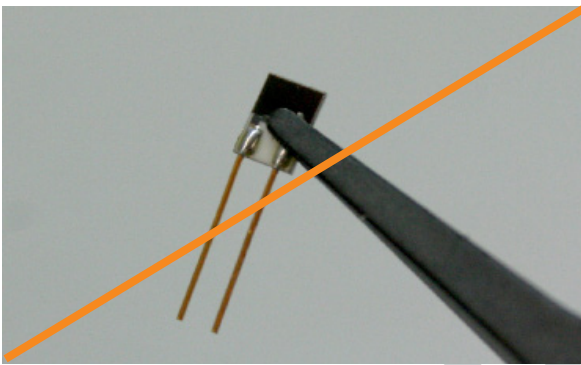
Hold the sensor with plastic tweezers or with gloves on the wires only.



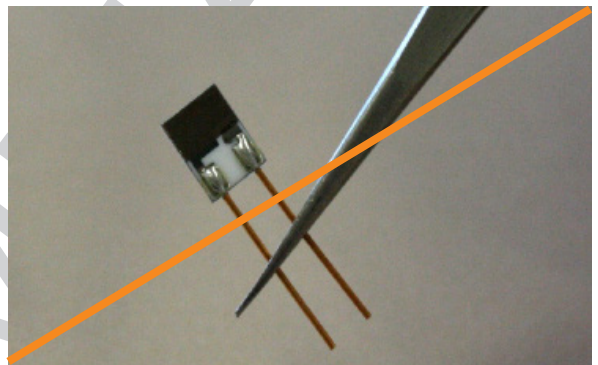
Picture 1: Sensor held on wires with plastic tweezers



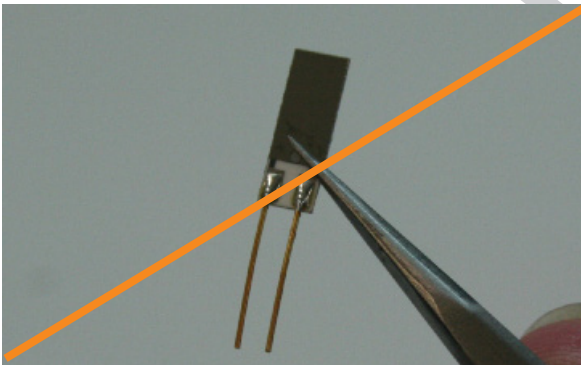
Picture 2: Sensor held with gloves



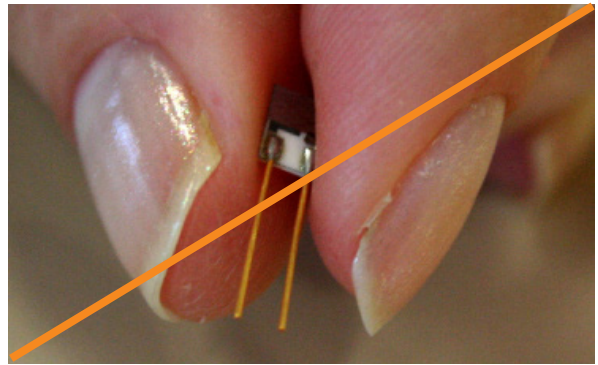
Picture 3: Sensor picked on the active area



Picture 4: Sensor picked on wires with metal tweezers



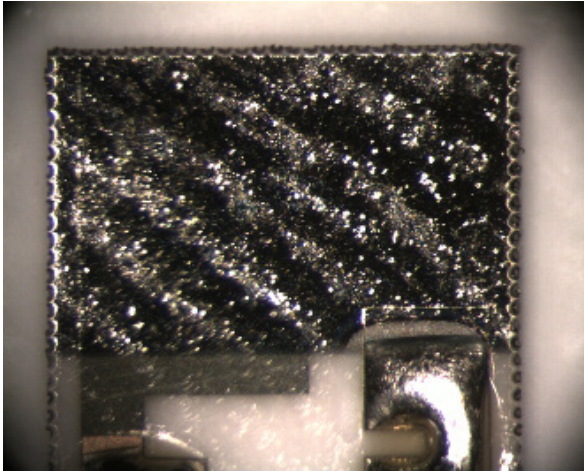
Picture 5: Sensor picked on the active area with metal tweezers



Picture 6: Sensor held with fingers without gloves on the active area

- Do not touch the active area of the sensor.
- Do not use metal tweezers to handle the sensors.
- Never handle the sensor by hand without gloves.

Do not touch or scratch the active area of the sensors. Scratches and contaminations can degrade the sensor characteristic (see bad samples in pictures 7 and 8 below).



Picture 7: Sensor with contaminations



Picture 8: Sensor with a scratch

- Avoid mechanical stress to the sensors, e.g. bending or touching with sharp objects.
- Hold the sensors with plastic tweezers on the side edges only.

Soldering of the sensor

- The maximum temperature of the soldering iron of 320 °C may not be exceeded. Maximum heat apply with the iron must be below 10 seconds at the very end of the connecting wires.
- The calibration of the sensors has to be done 5 days after soldering at earliest. This time is needed to provide a relaxation after the heat induces during the soldering process.
- Avoid soldering flux residues, caused by the soldering process, or any other contaminations inside the active area of the sensor.
- Soldering flux residues on the outside of the sensor's active area are not critical. If the sensor is mounted with glue we recommend baking the sensor at 80 °C for 1 hour after the gluing process.

Cleaning of the sensor

- Any residues can be easily removed with isopropanol at room temperature. Apply of low ultrasonic energy might improve the cleaning process. The sensor has to be dried after the cleaning process.
- The sensor cannot be cleaned mechanically with cotton swabs for instance.
- It is possible to clean the sensor with oil free and filtered clean air, e.g. for removing dust particles.



Innovative Sensor Technology IST AG, Stegrütistrasse 14, 9642 Ebnat-Kappel, Switzerland
Phone: +41 71 992 01 00 | Fax: +41 71 992 01 99 | Email: info@ist-ag.com | www.ist-ag.com

All mechanical dimensions are valid at 25 °C ambient temperature, if not differently indicated • All data except the mechanical dimensions only have information purposes and are not to be understood as assured characteristics • Technical changes without previous announcement as well as mistakes reserved • The information on this data sheet was examined carefully and will be accepted as correct; No liability in case of mistakes • Load with extreme values during a longer period can affect the reliability • The material contained herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner • Typing errors and mistakes reserved • Product specifications are subject to change without notice • All rights reserved

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Innovative Sensor Technology:](#)

[P14 Rapid-2_5](#)